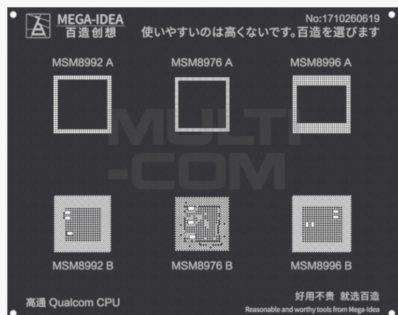


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MEGA- IDEA Black Stencils Qualcomm CPU MSM8992 A B | MSM8976 A B | MDM8996 A B

Product ID: 22496

Price: **9.00 EUR**

Product weight: **0.20 kg**

Description:

MEGA- IDEA Black Stencils Qualcomm CPU MSM8992 A B | MSM8976 A B | MDM8996 A B- is born for reballing tin balls, bring you unique using experience, making every tin ball round and full. Professional builder of black reballing stencils. great ordinariness. economic but functional.

Contact details:

Telefon: +48 17 227 00 25

Infolinia: 0 801 671 717

E-mail: biuro@multi-com.pl

Skype: Multi-COM

Address:

Multi-COM Sp. z o.o.

ul. Stanisława Krzaklewskiego 31b

36-100 Kolbuszowa

POLSKA

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